

# DuPont™ Kalrez® and Zalak® For Photovoltaic Manufacturing Processes

Technical Information — Rev. 6, July 2010

## Increase Uptime...

## Increase Throughput...

## Lower Cost of Ownership...

As the demand for photovoltaic systems continues to rise, manufacturers must find ways to increase uptime and improve output. Frequently, more aggressive and efficient chemicals, and/or higher temperatures are employed to increase throughput; thereby, putting more strain on the manufacturing infrastructure. Unplanned maintenance due to incompatible sealing materials can interfere with production schedules causing downtime. As a result, sealing materials in either wafer-based or thin film processes should have broad chemical compatibility and excellent thermal stability.

DuPont™ Kalrez® perfluoroelastomer parts have been field proven in highly aggressive sealing environments for more than 30 years. Kalrez® parts can help improve sealing reliability in photovoltaic processes that use high heat, aggressive chemicals and plasma. Kalrez® seals resist over 1,800 chemicals including reactive gases and plasmas, alkalis, acids and solvents. Even in contact with these corrosive chemicals, Kalrez® seals retain their elastomeric properties at temperatures as high as 325 °C.

The latest sealing product from DuPont, Zalak® 5300 high performance seals, join the Kalrez® perfluoroelastomer product line as a cost-effective alternative in select applications where traditional sealing materials are insufficient. It bridges the performance gap between standard fluoroelastomers (FKM) and perfluoroelastomers (FFKM) parts. Zalak® 5300 parts have been specially formulated for use in the different photovoltaic manufacturing processes.

On page 2 are the suggested Kalrez® or Zalak® products for use in the different photovoltaic cell manufacturing processes and for poly-silicon feedstock production and abatement systems.



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## Photovoltaic Product Selector Guide

### Silicon wafer-based cell manufacturing processes

<b>Surface Texturing/Cleaning</b> Kalrez® PV8030	<b>Doping</b> Kalrez® PV8070/ PV8050	<b>Edge Isolation</b> Zalak® 5300	<b>P Silicate Removal</b> Kalrez® PV8030	<b>ARC Coating</b> Zalak® 5300 / Kalrez® PV8050	<b>Metallization</b> Kalrez® PV8070	<b>Testing Sorting</b>
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Process Type	Typical Process Environment	Suggested DuPont Product
Wafer Sawing Damage Removal Surface Texturing and Cleaning	HF, HNO <sub>3</sub> , 80 °C Concentrated NaOH, KOH, IPA, HCl, Hot Water	Kalrez® PV8030
N-Doping	850–900 °C, POCl <sub>3</sub> Diffusion, In-Situ Cl <sub>2</sub> Cleaning	Kalrez® PV8070/PV8050
Edge Isolation	CF <sub>4</sub> /O <sub>2</sub> Plasma Etching	Zalak® 5300
P Silicate Removal	NaOH, KOH, HF, HNO <sub>3</sub> , HCl, etc.	Kalrez® PV8030
ARC Coating	SiH <sub>4</sub> , NH <sub>3</sub> , O <sub>2</sub> Plasma PECVD or Reactive Sputtering, In-Situ NF <sub>3</sub> Plasma Cleaning	Zalak® 5300/Kalrez® PV8050*
Metallization	Drying/Firing Process	Kalrez® PV8070

Other Process Types	Typical Process Environment	Suggested DuPont Product
Poly-Silicon Feedstock Production Siemens Technology	TCS CVD Deposition 1100°C, SiHCl <sub>3</sub> , HCl, H <sub>2</sub>	PV8070/PV8050
Abatement Systems ("Wet" Scrubbers)	Strong Acids/Bases	PV8030

### Thin film cell manufacturing processes

<b>Back Contact</b>	<b>Patterning</b> Laser Scribing	<b>Cell Layer Deposition</b> See Below For Product	<b>Patterning</b> Laser Scribing	<b>TCO Deposition</b> See Below For Product	<b>Patterning</b> Laser Scribing	<b>Testing</b>
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\* Note - The order of the process steps can be different depending upon the module construction sequence.

Process Type	Typical Process Environment	Suggested DuPont Product
Cell Layer Deposition/Absorber	SiH <sub>4</sub> , H <sub>2</sub> , Plasma PECVD, Remote NF <sub>3</sub> Plasma Cleaning	Kalrez® 9100/Zalak® 5300*
<ul style="list-style-type: none"> <li>• Amorphous/Micro-Crystalline Silicon</li> <li>• CIS/CIGS                             <ul style="list-style-type: none"> <li>○ Diffusion</li> <li>○ CdS Buffer Deposition</li> <li>○ Cu (In, GA) Sputtering</li> </ul> </li> <li>• Cadmium Telluride                             <ul style="list-style-type: none"> <li>○ Single Side Activation</li> <li>○ Cadmium Etching</li> <li>○ CdS Buffer Deposition</li> </ul> </li> </ul>	500–550 °C, H <sub>2</sub> Se, H <sub>2</sub> S Diffusion 65 °C, Cd & S Salts Dissolved in NH <sub>4</sub> OH 400-600 °C, Vacuum	Kalrez® PV8070 Kalrez® PV8030 Zalak® 5300
TCO Deposition/Front Contact	400 °C, CdCl <sub>2</sub> Dissolved in Methanol, Concentrated H <sub>3</sub> PO <sub>4</sub> , HNO <sub>3</sub> 65 °C, Cd & S Salts Dissolved in NH <sub>4</sub> OH ZnO Reactive Sputtering Diethyl Zinc (DEZ) MOCVD	Kalrez® PV8050 Kalrez® PV8030 Kalrez® PV8030 Zalak® 5300 Kalrez® PV8030

\*Contact a Kalrez® Application Engineer for the most appropriate product in this application

## **Suggested Products for Photovoltaic Use**

### **DuPont™ Kalrez® PV8030**

Kalrez® PV8030 perfluoroelastomer parts are a black product for PV cell manufacturing processes requiring resistance to “wet” process/cleaning chemistry including sawing damage removal, wafer surface texturing, P silicate removal and CdS buffer layer chemical bath deposition. It exhibits excellent resistance to aggressive chemicals including strong acids, bases, solvents and metal organic precursors. It also offers low metallic, anionic and total organic carbon (TOC) extractables and has excellent (low) compression set properties. Kalrez® PV8030 has good mechanical strength properties and is well suited for both static and dynamic sealing applications. A maximum continuous service temperature of 275 °C is suggested.

### **DuPont™ Kalrez® PV8050**

Kalrez® PV8050 perfluoroelastomer parts are a white product for PV cell manufacturing processes requiring resistance to “dry” process chemistry including TCS-based thermal CVD for poly-silicon feedstock production, plasma edge isolation and silicon nitride ARC Deposition. It exhibits very low weight loss in oxygen and fluorine-based plasma. It also offers excellent resistance to chlorine gas and has excellent (low) compression set and outgassing properties. Kalrez® PV8050 has good mechanical strength properties and is well suited for both static and dynamic sealing applications. A maximum continuous service temperature of 300 °C is suggested.

### **DuPont™ Kalrez® PV8070**

Kalrez® PV8070 perfluoroelastomer parts are a black product for PV cell manufacturing processes requiring high temperature resistance including doping for n-type layer formation (bulk c-Si), diffusion for Diselenide thermal implantation (CIGS) and TCS-based thermal CVD for poly-silicon feedstock production. It exhibits outstanding thermal stability and has excellent (low) compression set and outgassing properties. It also offers excellent resistance to chlorine and fluorine gas as well as other dry process chemistry. Kalrez® PV8070 has excellent mechanical strength properties and is well suited for both static and dynamic sealing applications. A maximum continuous service temperature of 325 °C is suggested. Short excursion to higher temperatures may also be possible.

### **DuPont™ Kalrez® 9100**

Kalrez® 9100 perfluoroelastomer parts are an amber translucent product for PV cell manufacturing processes requiring resistance to fluorine-based plasma including amorphous/microcrystalline silicon thin film deposition. It exhibits very low weight loss and ultra-low particle generation in fluorine-based plasma, e.g., NF<sub>3</sub>, F<sub>2</sub>, etc. It also offers excellent resistance to dry process chemistry and has excellent thermal stability, compression set and outgassing properties. Kalrez® 9100 has good mechanical strength properties and is well suited for both static and dynamic sealing applications. A maximum continuous service temperature of 300 °C is suggested.

### **DuPont™ Zalak® 5300**

Zalak® high performance seals are a beige translucent product that has been specially formulated for use in plasma environments, e.g., ARC coating in crystalline silicon cell manufacturing, TCO sputtering deposition and selective a-Si PECVD applications in thin film cell manufacturing. The low erosion rate of Zalak® 5300 in different plasma environments enables the PV cell manufacturing equipment to operate longer with reduced maintenance, effectively reducing the cost of equipment ownership. It also exhibits low “stiction” (sticking), good resistance to “dry” process chemistry and has excellent compression set properties. A maximum continuous service temperature of 200 °C is suggested.

## Photovoltaic Product Information

### Typical Physical Properties<sup>1</sup>

Product	Color	Hardness <sup>2</sup> Shore M (O-ring)	Maximum Continuous Service Temperature <sup>3</sup> , °C	Compression Set, 70 hrs at 204 °C <sup>4</sup> , %
Kalrez <sup>®</sup> PV8030	Black	83	275	30
Kalrez <sup>®</sup> PV8050	White	72	300	17
Kalrez <sup>®</sup> PV8070	Black	83	325	14
Kalrez <sup>®</sup> 9100	Amber Translucent	74	300	17
Zalak <sup>®</sup> 5300	Beige Translucent	65	200	35

<sup>1</sup> Not to be used for specification purposes

<sup>2</sup> ASTM D2240 and D1414 (AS568 K214 O-ring test specimens)

<sup>3</sup> DuPont Performance Polymers proprietary test method

<sup>4</sup> ASTM D395B and D1414 (AS568 K214 O-ring test specimens)

Visit us at [kalrez.dupont.com](http://kalrez.dupont.com) or [vespel.dupont.com](http://vespel.dupont.com)

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**Caution:** Do not use in medical applications involving permanent implantation in the human body. For other medical applications, discuss with your DuPont customer service representative and read Medical Caution Statement H-50103-3.

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